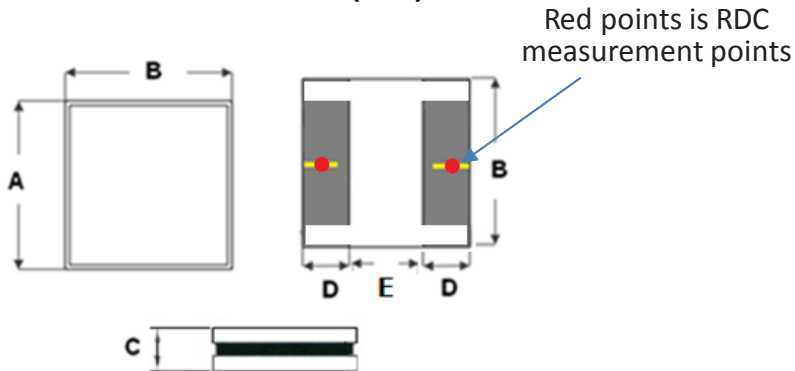


ITEM P/N	PHN4020A-SERIES	TEST INSTRUMENT	Microtest6379 / Agilent4338B
PRODUCT	Power Inductor	TEST FREQUENCY	100 KHz / 1V

PACKING DIMENSIONS (mm)

PHN4020	Dimensions
A	4.0 ± 0.2
B	4.0 ± 0.2
C	1.8 ± 0.2
D	1.2 Ref
E	1.6 Ref

EXPLANATION OF PART NUMBERS

1	2	3	4	5	6	7	8	9	10	
P	H	N	40	20	A	-	1	R	0	M
	①			②	③		④		⑤	

1. Product Name
2. Dimensions
3. Material
4. Inductance Code
5. Inductance Tolerance (N = 30% , M = 20%)

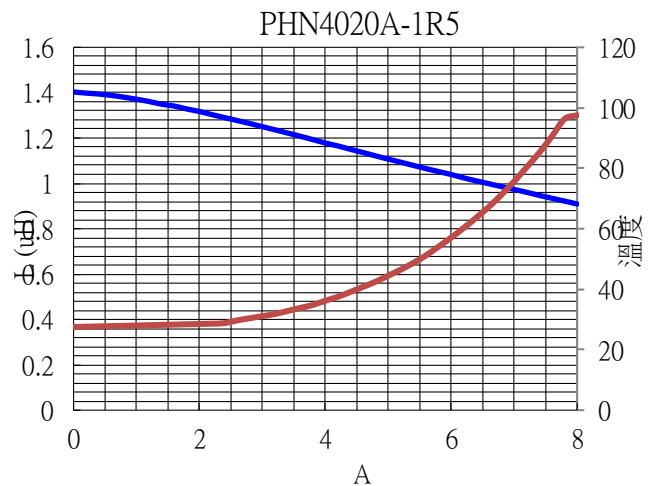
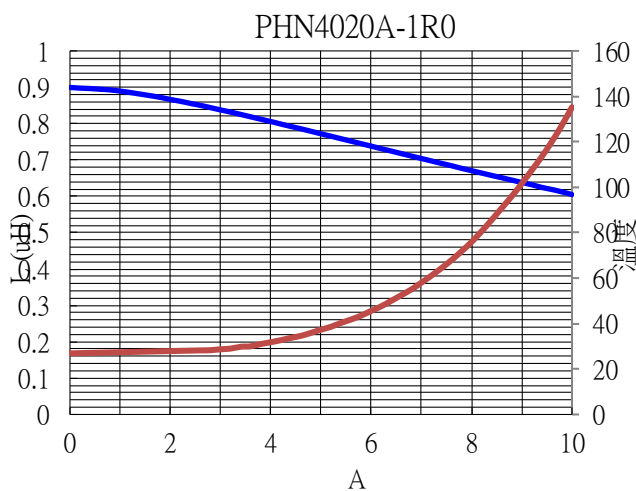
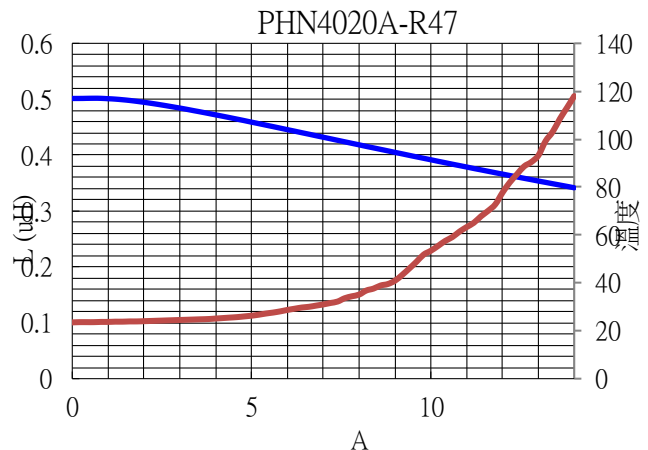
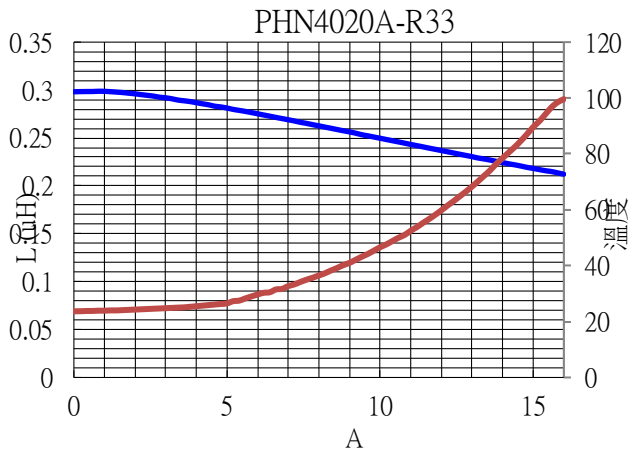
ELECTRICAL CHARACTERISTICS

HUNGTRON Part Number	Inductance (uH)	Test Frequency (KHz)	DCR (mΩ) Max	I sat (A) typ.	I rms (A) typ
PHN4020A-R33□	0.33	100	10	14.0	7.0
PHN4020A-R47□	0.47	100	17	12.0	6.0
PHN4020A-1R0□	1.00	100	35	7.5	4.5
PHN4020A-1R5□	1.50	100	45	6.5	3.8
PHN4020A-2R2□	2.20	100	55	5.5	3.5
PHN4020A-3R3□	3.30	100	75	4.5	2.8
PHN4020A-4R7□	4.70	100	95	3.8	2.3
PHN4020A-5R6□	5.60	100	105	3.4	2.0
PHN4020A-6R8□	6.80	100	120	3.0	1.6
PHN4020A-100□	10.0	100	160	2.5	1.3
PHN4020A-150□	15.0	100	300	2.3	1.8
PHN4020A-220□	22.0	100	400	2.2	1.9

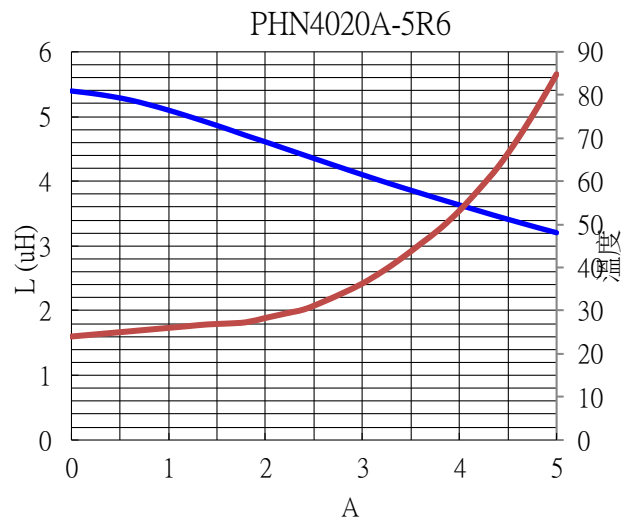
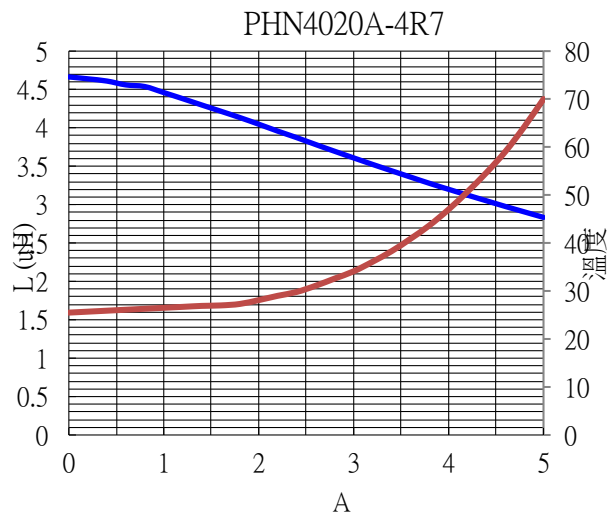
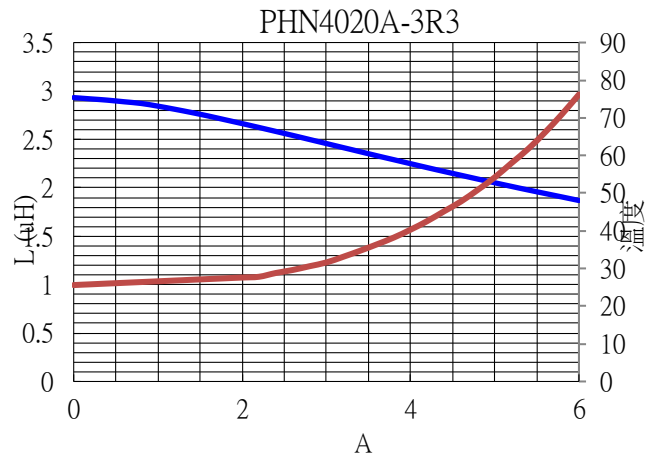
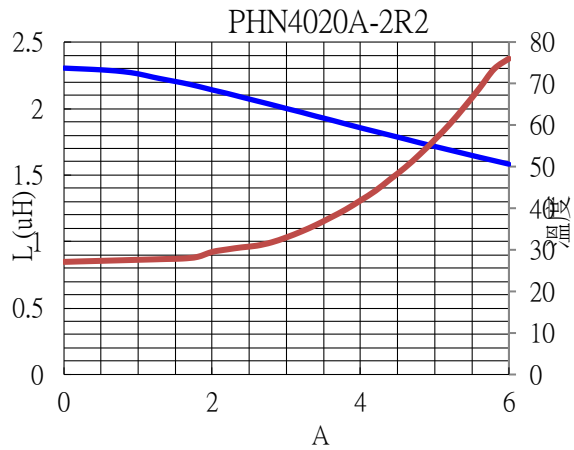
ITEM P/N	PHN4020A-SERIES	TEST INSTRUMENT	Microtest6379 / Agilent4338B
PRODUCT	Power Inductor	TEST FREQUENCY	100 KHz / 1V

Note :

- When ordering please specify tolerance and packaging codes.
- L: Microtest6379, 100KHz/1V
- RDC: Digital Milliohm Meter Agilent/HP4338B
- Isat & Irms : Microtest 6379, 100KHz/1V
- Isat for Inductance drop 30% from its value without current typical.
- Irms for a 40°C rise above 25°C ambient typical.
- If Use wave soldering is there will be some risk.(Crack、unwitting& Mark Shec
- Re-flow soldering temperatures below 240 degrees, there will be unwitting risk
- Operating Temperature Range -40°C to +125°C(Including self-temperature rise)
- When total area of exposed wire occurring to each sides is not greater than 75% of coating resin area, that is acceptable.

PERFORMANCE CURVES

ITEM P/N	PHN4020A-SERIES	TEST INSTRUMENT	Microtest6379 / Agilent4338B
PRODUCT	Power Inductor	TEST FREQUENCY	100 KHz / 1V

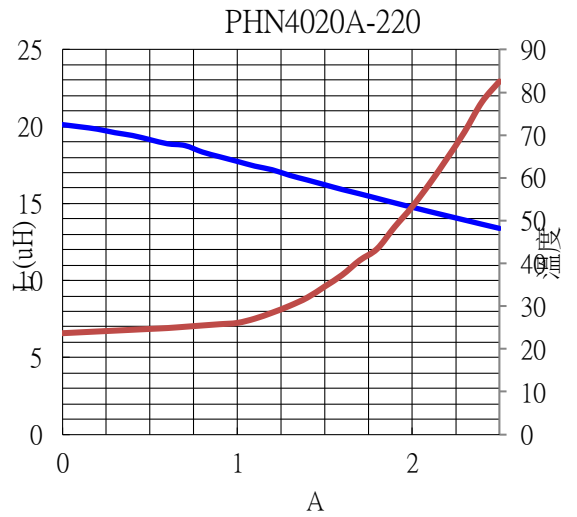
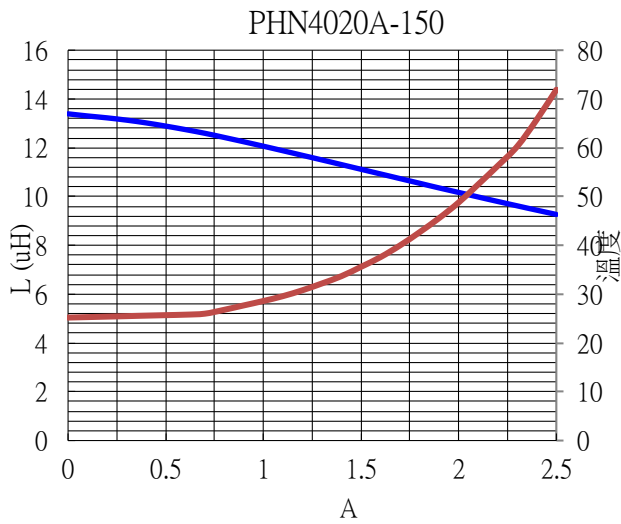
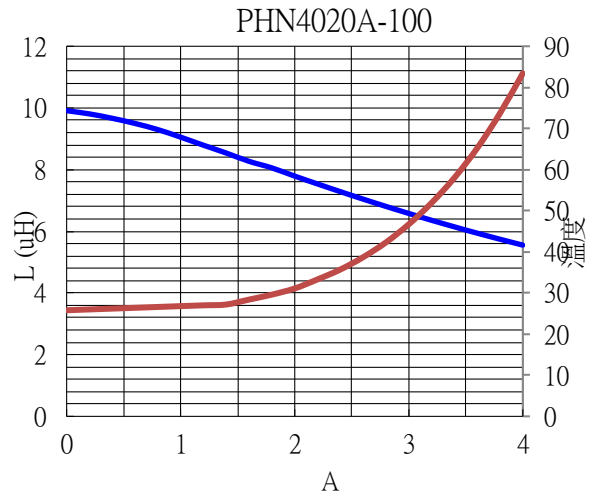
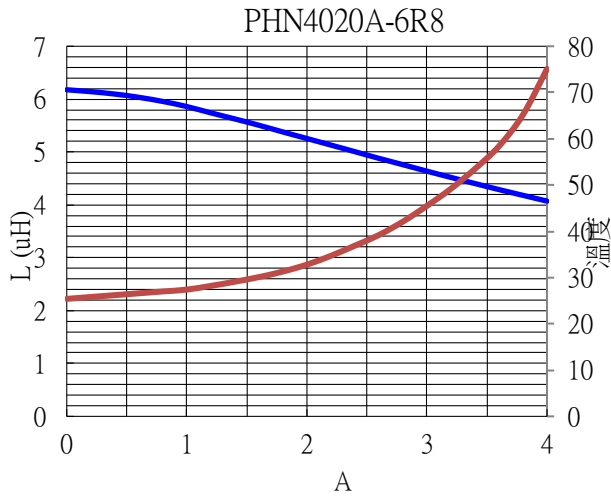
PERFORMANCE CURVES

CHARACTERISTICS

**RoHS
COMPLIANT**

ITEM P/N	PHN4020A-SERIES	TEST INSTRUMENT	Microtest6379 / Agilent4338B
PRODUCT	Power Inductor	TEST FREQUENCY	100 KHz / 1V

PERFORMANCE CURVES



ITEM P/N	PHN4020A-SERIES	TEST INSTRUMENT	Microtest6379 / Agilent4338B
PRODUCT	Power Inductor	TEST FREQUENCY	100 KHz / 1V

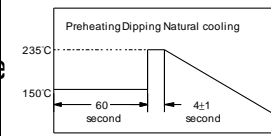
Reliability and Test Condition

Item	Performance	Test Condition
Operating Temperature	-40~+125°C (Including self temperature rise)	

Electrical Performance Test

Inductance L	Refer to standard electrical characteristic list	Agilent-4291, Agilent-4287 Agilent-4192, Agilent-4285
Q		
SRF		Agilent-4291
DC Resistance		Agilent-4338
Rated Current	Base on temp. rise & $\Delta L/L \leq 30\%$.	Saturation DC Current (Isat) will cause LO to drop approximately $\Delta L(\%)$.
Temperature Rise Test	?T 40?Max	Heat Rated Current (Irms) Will cause the coil temperature rise approximately $\Delta T(^{\circ}C)$ without core loss. 1. Applied the allowed DC current. 2. Temperature measured by digital surface thermometer

Mechanical Performance Test

Resistance to Soldering Heat MIL-STD-202 METHOD 210	1. Inductors shall be no evidence of electrical and mechanical damage. 2. Inductance within $\pm 10\%$ of initial value	Temp.: 260 \pm 5 $^{\circ}C$ Time: 10-1.0 Sec
Solderability Test ANSI/JSTD002	More than 95% of terminal electrode should be covered with solder.	 <p>Preheating Dipping Natural cooling</p> <p>235$^{\circ}C$ 150$^{\circ}C$ 60 second 4\pm1 second</p> <p>be dipped in a melted solder bath at 235$^{\circ}C$ for 4\pm1 seconds.</p>

CHARACTERISTICS

**RoHS
COMPLIANT**

ITEM P/N	PHN4020A-SERIES	TEST INSTRUMENT	Microtest6379 / Agilent4338B
PRODUCT	Power Inductor	TEST FREQUENCY	100 KHz / 1V

Reliability and Test Condition

Item	Performance	Test Condition													
Reliability Test															
Humidity Test MIL-STD-202 METHOD 103	1. Visual examination : No mechanical damage 2. Inductance : within $\pm 10\%$ of initial value	1. Temperature : $40 \pm 2^\circ\text{C}$ 2. Humidity : 90 ~ 95% 3. Time : 500 ± 8 hrs 4. Measured at room temperature after placing for 2 to 3 hrs													
Thermal Shock Test MIL-STD-202 METHOD 107															
High Temperature Life Test MIL-STD-202 METHOD 108		1. Temperature : $85 \pm 2^\circ\text{C}$ 2. Time : 500 ± 8 hrs 3. Measured at room temperature after placing for 2 to 3 hrs													
Humidity Resistance Test MIL-STD-202 METHOD 103		Conditions for 1 cycle <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>Step</th> <th>Temperature($^\circ\text{C}$)</th> <th>Times(min.)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-55 ± 2</td> <td>30 ± 3</td> </tr> <tr> <td>2</td> <td>Room</td> <td>Within 5</td> </tr> <tr> <td>2</td> <td>85 ± 5</td> <td>30 ± 3</td> </tr> </tbody> </table> Total: 100 cycles Measured at room temperature after placing for 2 to 3 hrs	Step	Temperature($^\circ\text{C}$)	Times(min.)	1	-55 ± 2	30 ± 3	2	Room	Within 5	2	85 ± 5	30 ± 3	Temperature: $40 \pm 2^\circ\text{C}$ Humidity: 90 ~ 95% 3. Time: 500 ± 8 hr. 4. Recovery: 2 to 3 hrs of recovery under the standard condition after the removal from test chamber.
Step		Temperature($^\circ\text{C}$)	Times(min.)												
1	-55 ± 2	30 ± 3													
2	Room	Within 5													
2	85 ± 5	30 ± 3													
Low temperature Storage Test JESD22-A119	1. Temperature : $-40 \pm 2^\circ\text{C}$ 2. Time : 500 ± 8 hrs 3. Measured at room temperature after placing for 2 to 3 hrs														
Random Vibration Test MIL-STD-202 Method 204	Appearance: Cracking, shipping and any other defects harmful to the characteristics should not be allowed. Impedance: within $\pm 30\%$	Frequency: 10-55-10Hz for 15 min. Amplitude: 1.52mm Directions and times: X, Y, Z directions for 15 min. This cycle shall be performed 12 times in each of three mutually perpendicular directions (Total 9 hours).													



ITEM P/N	PHN4020A-SERIES	TEST INSTRUMENT	Microtest6379 / Agilent4338B
PRODUCT	Power Inductor	TEST FREQUENCY	100 KHz / 1V

Soldering and Mounting**1. Soldering**

Mildly activated rosin fluxes are preferred. terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

1.1 Solder re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

1.2 Soldering Iron(Figure 2):

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

- Preheat circuit and products to 150 °C
- Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 355 °C tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4~5 sec.

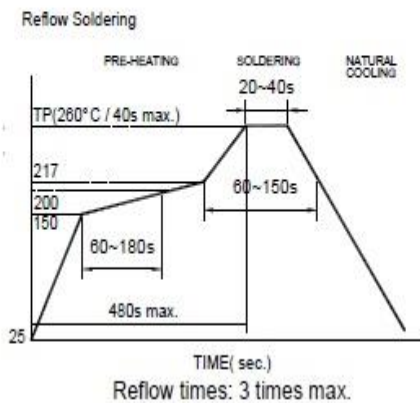


Fig.1

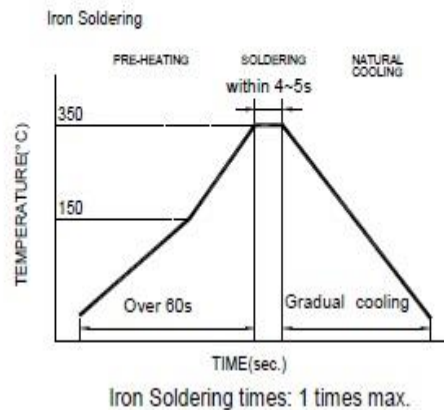
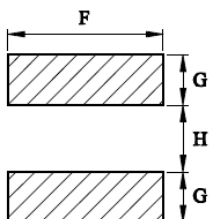
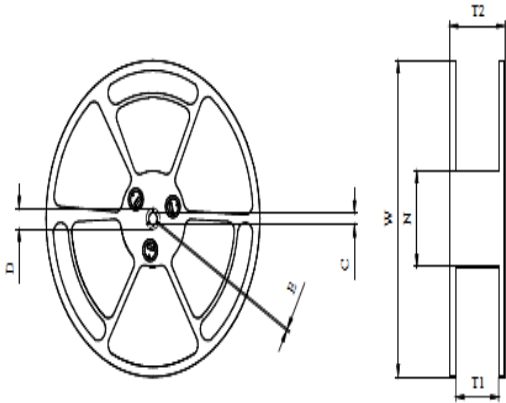


Fig.2

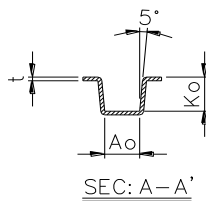
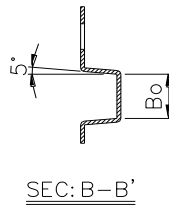
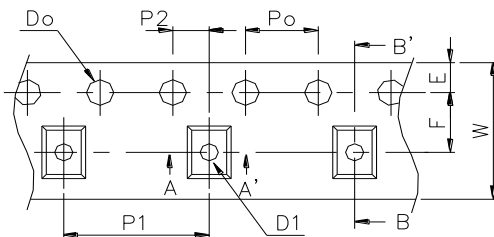
Recommended PC Board Pattern

Symbol	Dimension
F	4.0
G	1.2
H	1.6

ITEM P/N	PHN4020A-SERIES	TEST INSTRUMENT	Microtest6379 / Agilent4338B
PRODUCT	Power Inductor	TEST FREQUENCY	100 KHz / 1V

Packaging Information**Reel Dimension**

Type	W(mm)	D(mm)	C(mm)	T1(mm)	N(mm)	T2(mm)	E(mm)
φ 330	330±1.5	21.5+0.5/-0	13+0.5-0.2	2.5+0.5/-0	100±1.5	16.9±0.4	2.00±0.5

Tape Dimension

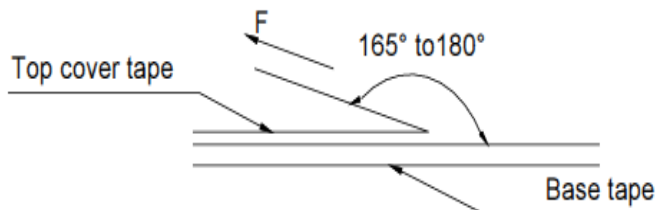
Item	specification	Tol.(+/-)
W	12.00	±0.20
E	1.75	±0.10
F	5.50	±0.05
D0	1.50	+0.10,-0
D1	1.50	±0.10
P0	4.00	±0.05
P1	8.00	±0.10
P2	2.00	±0.05
P0*10	40.00	±0.20

Item	specification	Tol.(+/-)
t	0.25	±0.05
A0	4.25	±0.10
B0	4.25	±0.10
K0	2.05	±0.10

ITEM P/N	PHN4020A-SERIES	TEST INSTRUMENT	Microtest6379 / Agilent4338B
PRODUCT	Power Inductor	TEST FREQUENCY	100 KHz / 1V

Packaging Quantity

Chip size	Chip/Reel
PHN4020	2000

Tearing Off Force**Tearing Off Force**

The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

Application Notice

• Storage Conditions

To maintain the solderability of terminal electrodes:

1. products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
2. Temperature and humidity conditions: Less than 40°C and 60% RH.
3. Recommended products should be used within 12 months form the time of delivery.
4. The packaging material should be kept where no chlorine or sulfur exists in the air.

• Transportation

1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
3. Bulk handling should ensure that abrasion and mechanical shock are minimized.